

TACT SWITCH SPECIFICATION(轻触开关说明书)

- **1.** General specification 基本说明
 - **1.1** Scope 范围 This specification covers the requirements for single key switches which have no keytop (TACT SWITCHES:MECHANICAL CONTACT). 此规范含盖单推柄和无推柄的轻触开关要求。
 - 1.2 Operating Temperature Range 使用温度范围

-55 to 125 ℃ (normal humidity, normal press).正常湿度,标准压力

1.3 Storage Temperature Rang 保存温度范围

-25 to 85 °C (normal humidity, normal press).

1.4 Test Conditions 测试条件

Tests and measurements shall be made in the following standard clnditions unless otherwise specified:

测试和计量按下列标准条件除非特殊说明

Normal temperature (temperature 5 to 35℃) 标准温度

Normal humidity (relative humidity 45 to 85%) 正常湿气

Normal pressure (pressure860 to 1060 mbars) 标准压力

In case any question arises from the judgement made, tests shall be conducted in the following conditions:

Temperature (20±2℃) 温度

Relative humidity (65±5%) 相对湿度

Pressure (860 to 1060 mbars) 压力

- 2. APPEARNCE, STYLE, AND DIMENSIONS 外形, 类型和尺寸
 - **2.1** Appearance 外形

There shall be no defects that affect the serviceability of the product 外形必须无缺陷才不影响产品适用性

2.2 Style and Dimensions 类型和尺寸

Shall conform to the assembly drawings. 符合装配图

3. TYPE OF ACTUATION 动作类型

Tactile feedback 轻触返回

4. CONTACT ARRANGEMENT <u>1</u> poles <u>1</u> throws 接触形式 1 接点 1 回路

(Details of contact arrangement are given in the assembly drawings).

细接点形式在装配图中

5. MAXOMUM RATINGS DC <u>12</u> V <u>50</u> mA 最大额定值

						APPD	CHKD	DSGD	TC-1109DF		
									1C-1109DF		
									1/7		
ZONE	SYMB	DATE	APPD	CHKD	DSGD						

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6.2Mechanical 机械特性	6.2	Mec	hanical	机械特性
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Item 项 目			Test C	onditior	试验条	件		F	Requirements 规 格		
6.2.1.	Placing	the s	witch su	uch that	the d	irection	of switc	h			
Actuating Force	operat	ion is v	ertical a	nd then	gradua	ally incre	asing th	е			
动作力	load a	oplied to	the cen	ter of the	e stem,	the maxi	mum loa	d			
	require	ed for t	the sten	n to co	me to	a stop	shall b	e 160gf±50 gf			
	measu	red.									
	开关的表	动作方向	为垂直放	置开关向	推柄中心	逐渐增加	负荷直到拮	雀			
	柄停止	寸所测量的	的最大负荷	扩							
6.2.2.	Placing	g the s	witch su	uch that	t the d	irection	of switc	h			
Travel	operat	ion is ve	ertical an	d then a	pplying	a static l	oad twic	е			
行程	the ac	tuation f	orce to	the cent	the trave	əl					
	distand	e for	the sten	n to co	shall b	e 0.2±0.1mm					
	measu	red.									
	开关的表	动作方向	为垂直放置	置开关,在	已有行程	目的推柄中	心向上减少	小			
	压力, 技	作柄回到	自由位置的	计所测到的	力						
6.2.3.	The sa	ample sv	witch is i	nstalled	such th	at the d	irection o	of			
Return Force	switch	operation	on is ver	tical and	d, upon	depress	ion of th	е			
返回力	stem ii	n its cer	nter the v	of	70gf min						
	the ste	m to ret	urn to its		rogi iliili						
	开关的表	动作方向	垂直放置开	玉							
	力,推构	两回到自6	由位置时所	斤测量到的	力						
6.2.4.	Placing	g the s	witch su	uch that	t the d	irection	of switc	h			
Stop	operat	ion is v	ertical,	a static	load of	f <u>3</u> kgf	shall b	е	There shall be no sign of		
Strength	applied	d in the	direction	of stem	n operat	ion for a	period o	of	damage mechanically and		
静止强度	<u>60</u> se	econds.							electrically		
	开关的表	动作方向之	为垂直放置	置开关,在	推柄动作	方向施加	3 KG 的	静	无机械的和电气的损伤迹象		
	负荷,6	60 秒时间									
6.2.5.	Placing	g the s	witch su	uch that	t the d	irection	of switc	h			
Stem	operat	ion is ve	ertical, th	ne maxir	mum fo	rce to wi	thstand	а			
Strength	pull ap	plied o	ppsite to	the di	rection	of stem	operatio	n	3 kgf		
推柄的强度	shall b	e meası	ured.						o kgi		
	开关的	动作方向	为垂直放	力							
1	所测量到										
					APPD	CHKD	DSGD		TC-1109DF		
									2/7		
ZONE SYMB	DATE	APPD	CHKD	DSGD					 -		

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6.PERFORMANCE 性能

6.1 Electrical 电气

Item 项	1		7	Test Con	dition 试				Requirements 要求
6.1.1. Contact Resistanc 接触电阻	e a	center o a 1 kh 用两倍的	of the st	em, mea -currentc =静负载施	suremen	nts shall esistanc	ng force t be made e meter. 并用 1 千	e with	<u>100</u> mΩmax.
6.1.2. Insulation Resistanc 绝缘电阻	e t	DC 10	00 V als and fi		across one minu	termina ute.	applicati Is and a 一分种		<u>100</u> MΩmin
6.1.3. AC250V (50Hz or 60Hz) shall be applied across terminals and frame for on minute. voltage 电气耐压 60Hz) defends d									There shall be mo breakdown 没有击穿
6.1.4. Bounce 抖动	6 5 t	encoun sec), E tested a 在正常使	ntered in Bounce s at "ON" a	n normal shall be and "OFF 每秒 3-4 岁	use (3	s to 4 o	em at a pperation 所中心加力	s per	<u>5</u> m sec max .
						APP	CHKD	DSGD	TC-1109DF
									3/7

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6.3 Environmental 环境

Item 项 目			Test Co	ndition	试验条件	<u> </u>		Requirements 要求
6.3.1. Resistance to Low Temperatures 耐低温	left in mone hou 样品按下上放置 (1) Tem (2) Time	ng the the four before 列条件员 小时 perature: 96 hc	test set f tempera e measu 进行耐低温	forth bel ture and irements 註试验,测 -2°C 》	ions for	Item 6.1 Item 6.2.1 Item 6.2.2		
6.3.2. Heat Resistance 耐热	Followin left in n one hou 件进行耐	ng the to normal to ur befor t热试验, peratur	test set f temperat e measu 测试前在 re:80±10 ne: 96 ho	forth bel cure and rements E正常温度	ons for 安下列条	Item 6.1 Item 6.2.1 Item 6.2.2		
6.3.3. Moisture Resistance 耐潮湿	left in none hoom 条件进行小时 (1) (2) Relate(3)	normal tur befo 计耐潮湿计 Tem ative hu	test set freemperatere meas 试验,测证 peraturer midity: 9 Time s shall be	ons for 品按下列	Contact resistance: 100 m ohm max 接触电阻 Insulation resistance 100 M ohm min.绝缘电阻 Item 6.1 Item 6.2.1 Item 6.2.2			
6.3.4. Temperature Cycling 温度循环	Following normal before n 环试验,	g the testemperation teasurer 测试前在	st set fort ture and ments are 生正常温度 water drop	Item 6.1 Item 6.2.1 Item 6.2.2				
					APPD	CHKD	DSGD	TC-1109DF
ZONE SYMB	DATE	APPD	CHKD	DSGD				4/7

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6.4 Endurance	耐久特性											
Item 项 目		Те	st Cond	lition 试	验条件			Requirements 要求				
6.4.1. Operating Life 动作寿命	Measure set fouth (1)DC 5\ 载 (2) Rate 动作频率: (3)Depre (4) Cycle 动作次	of ope	r: resistive ration:1 8 次/每分 : 260±50 peration	t负 Ins 10 nin Ac	ontact resistance: 00mΩ max 接触电阻 sulation resistance: 00MΩmin.绝缘电阻 stuating force: 动作力 +_15 % or -15%of initial force. 5%初始动作力 Item 6.1.3 Item 6.2.2							
6.4.2. Vibration Resistance 耐振动	(2) Amp 1.5n (3) Cycl appr (4) Mod (5) uni 内 (6) Dire Thre inclu 3个 ⁷ (7) Dura 2 hoo 共 6	below: age of colitude, mm le of some some section of the section	: 按下列约 pscillation pk-to 一 weep: weep: Leweep. 挂 of oscillate ually per he directe 直方向,包 f testing h, for a to	- 峰 ite, }钟	Item 6.1 Item 6.2.1 Item 6.2.2							
6.4.3. Impact Shock Resistance 抗冲击	(1) Accel (2) Cycle (3) for a	elow: ∄ leration es of te a total o	按下列条件 ∩:80g 力 est:3 cyc	⊨进行冲击 □速度 cles each les	set	Item 6.1 Item 6.2.1 Item 6.2.2						
					APPD	CHKD	DSGD	TC-1109DF				
ZONE SYMB	DATE /	APPD	CHKD	DSGD				5/7				

			CTIN	1G :	SWITC	CH	SPEC	FICAT	ION
(1) Foli	ن eguard t	he sold 进行焊接让 the swit 防止助焊剂	ering pr 过程中,才 ch asse 孙从开关的	ocess,d 「可以用溶 mbly ag 的顶端渗入	?剂或类似 painst flu 、。	品清洗开 IX pene	关 tration f	rom its t	
(3) Fie	c	deliverir	ng the g	oods at	most.		i the sto : 90 天以」		ne is 90 days guaranty after
						APPD	CHKD	DSGD	TC-1109DF
ZONE	SYMB	DATE	APPD	CHKD	DSGD				6/7

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7.2 SWITCH HANDLING PRECAUTION 使用开关时注意事项

1. In case an automatic flow soldering apparatus is use for soldering.

用自动焊接设备焊接时应参照如下条件

ITEM	SOLDERING CONDITIONS
项 目	焊接条件
PREHEAT TEMPERATURE 预热温度	180℃ MAX (AMBIENT TEMPERATURE OF PRINTED CIRCUIT BOARD ON ITS SOLDERING SIDE) (电路板周围焊锡面的温度)
PREHEAT TIME	45 SEC MAX
预热时间	45 秒 MAX
FLUX FOAMING 助焊剂浸泡	TO SUCH AN EXTENT THAT FLUX WILL BE KEPT FLUSH WITH THE PRINTED CIRCUIT BOARDS, TOP SURFACE ON WHICH COMPONENTS ARE MOUNTED. PRDPARATORY FLUX MUST NOT BE APPLIED TO THAT SODE OF PRINTED CIRCUIT BOARD ON WHICH COMPONENTS ARE MOUNTED AND TO THE AREA WHIERE TERMINALS ARE LOCATED. 助焊剂应涂在电路板上组装开关的印刷面上半部位,应防止助 焊剂过量到电路板 .
SOLDERIN	265°C MAX
TEMPERATURE	265℃ MAX
焊锡温度	
DURATION OF SOLDER IMMERSION 焊接时间	5 SEC MAX 5 秒 MAX
ALLOWABLE PREQUENCY 允许重焊次数	2 TIMES MAX 2 次 MAX

2. Other precautions 其他注意事项

(1) FOLLOWING THE SOLDERING PROCESS, DO NOT TRY TO CLEAN THE SWITCH SOLVENT OR THE LIKE.

进行焊接工艺时不应使用不整洁的东西对开关进行清洁。

(2) SAFEGUARD THE SWITCH ASSEMBLY AGAINST FLUX PENETRA TION FROM ITS TOP SIDE. 在组装开关时应防止助焊剂从开关的上部流入到开关内部。

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ZONE	SYMB	DATE	APPD	CHKD	DSGD				111